

## 940nm 4W VCSEL Chip VC-0940I-004W-46-0A0

## FEATURES

- 940nm single wavelength
- Low wavelength drift
- Oxide isolation technology
- Low threshold current
- Small emission area
- Easy to collimate

## **APPLICATIONS**

- 3D sensors
- Lidars
- IR illuminations
- Medical applications
- Proximity sensors
- Industrial application

Part Number	Description			
VC-0940I-004W-46-0A0	940nm 4W VCSEL Chip			

# PRODUCT IDENTIFY

## Code Rules

<u>VC</u>	-	<u>0940</u>	<u> </u>	-	<u>004</u>	W	-	<u>46</u>	-	<u>0</u>	<u>A</u>	<u>0</u>											
1	-	2	3	-	4	5	-	6	-	7	8	9											
													Annex, 0										
													Product Version, A										
													Accessories, 0										
													PCE, 46%										
													Power units, W = Watts										
																							Power value, 4
													Classification, I= Industrial level										
													Wavelength, 940nm										
													Header, short form of VSCEL Chip										

## I. Absolute maximum ratings

Parameter	Symbol	Rating	Unit
Case Operating Temperature	T <sub>op</sub>	-40 to +85	°C
Storage Temperature	T <sub>sto</sub>	-40 to +105	°C
Reflow Soldering Temperature	T <sub>sdr</sub>	320°C (10s)	١
Reverse Voltage	Vr	5	V
Maximum Continuous Current	I <sub>max</sub>	5	А
ESD exposure (Human body) model	ESD	2К	V

Note:

1. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating



only and functional operation of the device at these or other conditions above those indicated in the operations section for extended periods of time may affect reliability.

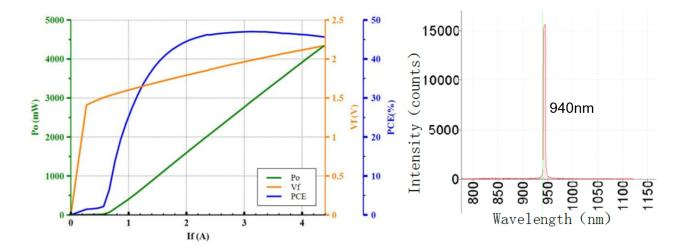
- 2. In its maximum rating diode laser operation could damage its performance or cause potential safety hazard such as equipment failure.
- 3. Electrostatic discharge is the main reason for the laser fault of the diode. Take effective precautions against ESD. When dealing with laser diodes, use the wrist strap, grounding work surface and strict antistatic technology.

### II. Optical-electrical characteristics @25°C , pulse width0.2ms, duty cycle1%

Parameters	Symbol	Condition	Min.	Тур.	Max.	Unit
Threshold Current	l <sub>th</sub>		-	0.6	-	A
Forward Current	lF		-	4.07	-	А
Optical Power	Po	I <sub>F</sub> =4.07A	-	4	-	W
Laser Forward Voltage	V <sub>f</sub>	I <sub>F</sub> =4.07A	-	2.13	-	V
Power conversion efficiency	η	I <sub>F</sub> =4.07A	-	46.2	-	%
Slope efficiency	SE	P <sub>o</sub> =4W	-	1.13	-	W/A
Series Resistance	R	I <sub>F</sub> =4.07A	-	0.14	-	Ω
Peak Wavelength	-	I <sub>F</sub> =4.07A	930	940	950	nm
Wavelength-Temp. Drift	$\Delta\lambda/\Delta T$	I <sub>F</sub> =4.07A	-	-	0.07	nm/°C
Beam divergence	<b>FWHM</b> B		-	20	-	deg
Emission area			-	846x811	-	um <sup>2</sup>
No. of Emission Aperture			-	598	-	

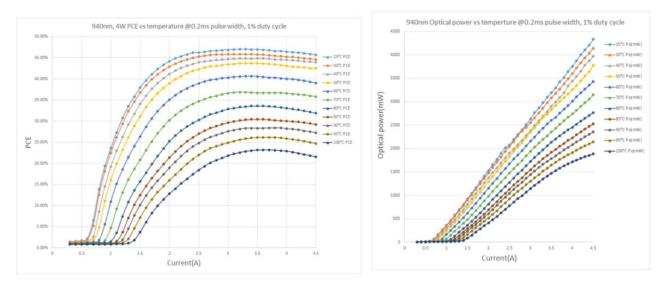
**Note:** Electro-Optical Characteristic with a package or diffuser would require further evaluation. Values are based on limited sample size and estimated values.

## III. Typical Performance LIV curve and Spectral Width

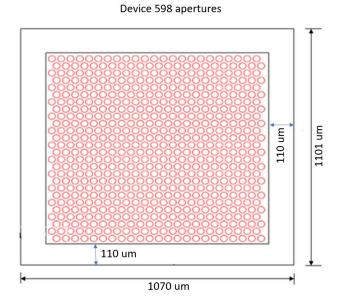




### High temperature testing 25℃ to 100℃



## IV. Mechanical Schematics (unit : um) VC-0940I-004W-46-0A0 with No. of Emission Aperture [598]



**Note:** There may be some changes between sample and drawing  $\cdot$  thus  $\cdot$  the actual spec please refer to the sample that you received. And if any inquires please contact us.

## V. Packaging Suggestion

For packaging, the user should use high thermal conductive substrate with AIN or copper; the user also attaches die onto the substrate using high thermal conductive materials such as nanosilver gel or AuSn. The user should have the equipments such as die attachment, wire bonder etc., which should be located in 1000 class clean room. For further assistance in need, please feel free to contact Brightintelligence! We would work with you to solve your issues.

## VI. Treatment and protection measures



#### **Soldering precautions**

The operator should examine grounding of machines before die attachment; and operator. should wear electrostatic bracelet to prevent die from damaging caused by electrostatic discharging.

#### Storage precautions

VCSEL bare dies must be stored in Nitrogen gas cabinet with >99% concentration at 20°C.

### VII. Revision History

Revision	Date	Description
Spec V.01	2020/06/23	The first official edition [0005C3 <sub>H</sub> ,0005C4 <sub>H</sub> ]

Note: Brightlaser reserves the right to make modification at any time due to improved design from time to time, the merit behind is to supply the

best product possible.